RESPONSE

USSN 10/068,159

Application:

10/068,159

Filing Date:

February 5, 2002

Inventors:

Hock Chuan Tan, et al.

Title:

Stacked Die In Die BGA Package

Examiner:

Thao P. Le

Art Unit:

2818

Attorney Docket:

MTI-31608 (15225:0049)

Confirmation No.:

8043

CERTIFICATION UNDER 37 CFR 1.8(a) and 1.10

I hereby certify that, on the date shown below, this correspondence is being:

deposited with the United States Postal Service in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

37 CFR 1.8(a)
37 CFR 1.10
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<u>Transmission</u>

transmitted by facsimile to Fax No. (703) 308-7722 addressed to Examiner Le at the Parent and Trademark Office,

Date: July 28, 2003

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE

Dear Sir:

Please see the attached.

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PATENT RESPONSE

INTRODUCTORY COMMENTS

After careful review, Applicant hereby responds to a May 27, 2003 non-final Office Action regarding the above-referenced patent application. In view of this Response, Applicant respectfully requests reconsideration of said application.

Applicant has not added new matter with this Response, and intends the scope of the invention and previously pending claims to be the same before and after this Response. Indeed, Applicant only offers this Response to clarify the invention for the Examiner, and to assist the Examiner's understanding of the same. More specifically, Applicant has not intended this Response to effectuate a narrowing of the claims, foreclose techniques that are not reasonably foreseeable at this time, or effect the applicability and scope of the Doctrine of Equivalents.

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